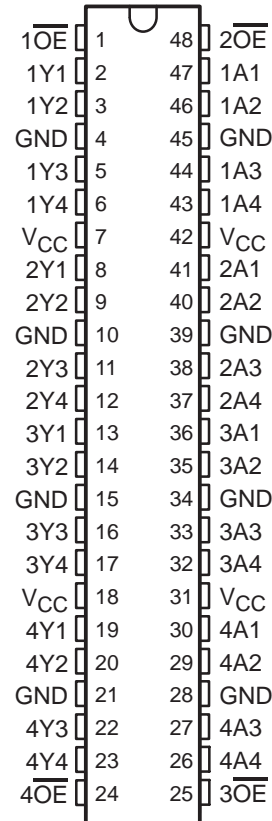


# SN54LVTH162244, SN74LVTH162244 3.3-V ABT 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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- Members of the Texas Instruments Widebus™ Family
- Output Ports Have Equivalent 22-Ω Series Resistors, So No External Resistors Are Required
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V  $V_{CC}$ )
- Support Unregulated Battery Operation Down to 2.7 V
- Typical  $V_{OLP}$  (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Distributed  $V_{CC}$  and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

SN54LVTH162244 . . . WD PACKAGE  
SN74LVTH162244 . . . DGG OR DL PACKAGE  
(TOP VIEW)



## description/ordering information

The 'LVTH162244 devices are 16-bit buffers and line drivers designed for low-voltage (3.3-V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment. These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs.

## ORDERING INFORMATION

| $T_A$          | PACKAGE†              |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING  |
|----------------|-----------------------|---------------|-----------------------|-------------------|
| –40°C to 85°C  | SSOP – DL             | Tube          | SN74LVTH162244DL      | LVTH162244        |
|                |                       | Tape and reel | SN74LVTH162244DLR     |                   |
|                | TSSOP – DGG           | Tape and reel | SN74LVTH162244DGGR    | LVTH162244        |
|                | VFBGA – GQL           | Tape and reel | SN74LVTH162244KR      | LL2244            |
|                | VFBGA – ZQL (Pb-free) |               | 74LVTH162244ZQLR      |                   |
| –55°C to 125°C | CFP – WD              | Tube          | SNJ54LVTH162244WD     | SNJ54LVTH162244WD |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# SN54LVTH162244, SN74LVTH162244

## 3.3-V ABT 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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#### description/ordering information (continued)

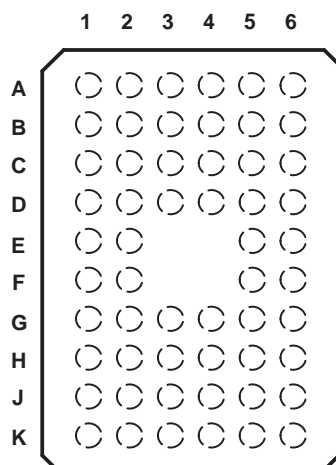
The outputs, which are designed to source or sink up to 12 mA, include equivalent 22-Ω series resistors to reduce overshoot and undershoot.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

#### GQL OR ZQL PACKAGE (TOP VIEW)



#### terminal assignments

|   | 1                 | 2   | 3        | 4        | 5   | 6                 |
|---|-------------------|-----|----------|----------|-----|-------------------|
| A | 1 $\overline{OE}$ | NC  | NC       | NC       | NC  | 2 $\overline{OE}$ |
| B | 1Y2               | 1Y1 | GND      | GND      | 1A1 | 1A2               |
| C | 1Y4               | 1Y3 | $V_{CC}$ | $V_{CC}$ | 1A3 | 1A4               |
| D | 2Y2               | 2Y1 | GND      | GND      | 2A1 | 2A2               |
| E | 2Y4               | 2Y3 |          |          | 2A3 | 2A4               |
| F | 3Y1               | 3Y2 |          |          | 3A2 | 3A1               |
| G | 3Y3               | 3Y4 | GND      | GND      | 3A4 | 3A3               |
| H | 4Y1               | 4Y2 | $V_{CC}$ | $V_{CC}$ | 4A2 | 4A1               |
| J | 4Y3               | 4Y4 | GND      | GND      | 4A4 | 4A3               |
| K | 4 $\overline{OE}$ | NC  | NC       | NC       | NC  | 3 $\overline{OE}$ |

NC – No internal connection

#### FUNCTION TABLE (each 4-bit buffer)

| INPUTS          |   | OUTPUT<br>Y |
|-----------------|---|-------------|
| $\overline{OE}$ | A |             |
| L               | H | H           |
| L               | L | L           |
| H               | X | Z           |

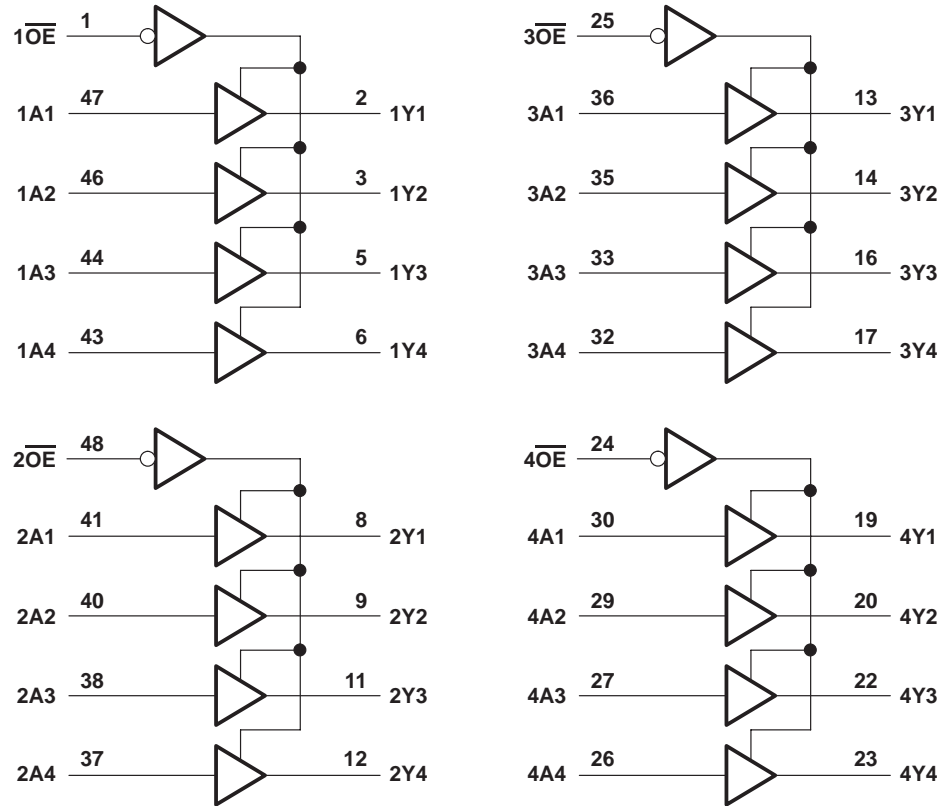
# SN54LVTH162244, SN74LVTH162244

## 3.3-V ABT 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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#### logic diagram (positive logic)



Pin numbers shown are for the DGG, DL, and WD packages.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$   | –0.5 V to 4.6 V            |
| Input voltage range, $V_I$ (see Note 1)  | –0.5 V to 7 V              |
| Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) | –0.5 V to 7 V              |
| Voltage range applied to any output in the high state, $V_O$ (see Note 1)                        | –0.5 V to $V_{CC} + 0.5$ V |
| Current into any output in the low state, $I_O$  | 30 mA                      |
| Current into any output in the high state, $I_O$ (see Note 2)                                    | 30 mA                      |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )  | –50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )   | –50 mA                     |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package                               | 70°C/W                     |
| DL package   | 63°C/W                     |
| GQL/ZQL package  | 42°C/W                     |
| Storage temperature range, $T_{stg}$   | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .
  3. The package thermal impedance is calculated in accordance with JESD 51-7.



# SN54LVTH162244, SN74LVTH162244

## 3.3-V ABT 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 4)

|                          |                                    |                 | SN54LVTH162244 |     | SN74LVTH162244 |     | UNIT      |
|--------------------------|------------------------------------|-----------------|----------------|-----|----------------|-----|-----------|
|                          |                                    |                 | MIN            | MAX | MIN            | MAX |           |
| $V_{CC}$                 | Supply voltage                     |                 | 2.7            | 3.6 | 2.7            | 3.6 | V         |
| $V_{IH}$                 | High-level input voltage           |                 | 2              |     | 2              |     | V         |
| $V_{IL}$                 | Low-level input voltage            |                 |                | 0.8 |                | 0.8 | V         |
| $V_I$                    | Input voltage                      |                 |                | 5.5 |                | 5.5 | V         |
| $I_{OH}$                 | High-level output current          |                 |                | –12 |                | –12 | mA        |
| $I_{OL}$                 | Low-level output current           |                 |                | 12  |                | 12  | mA        |
| $\Delta t/\Delta v$      | Input transition rise or fall rate | Outputs enabled |                | 10  |                | 10  | ns/V      |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 |                 | 200            |     | 200            |     | $\mu$ s/V |
| $T_A$                    | Operating free-air temperature     |                 | –55            | 125 | –40            | 85  | °C        |

NOTE 4: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER            |  | TEST CONDITIONS   |                             | SN54LVTH162244 |      |             | SN74LVTH162244 |      |             | UNIT    |
|----------------------|--|---|-----------------------------|----------------|------|-------------|----------------|------|-------------|---------|
|                      |  |   |                             | MIN            | TYP† | MAX         | MIN            | TYP† | MAX         |         |
| $V_{IK}$             |  | $V_{CC} = 2.7$ V,   | $I_I = -18$ mA              |                |      | –1.2        |                |      | –1.2        | V       |
| $V_{OH}$             |  | $V_{CC} = 3$ V,   | $I_{OH} = -12$ mA           | 2              |      |             | 2              |      |             | V       |
| $V_{OL}$             |  | $V_{CC} = 3$ V,   | $I_{OL} = 12$ mA            |                |      | 0.8         |                |      | 0.8         | V       |
| $I_I$                |  | $V_{CC} = 0$ or 3.6 V,  | $V_I = 5.5$ V               |                |      | 10          |                |      | 10          | $\mu$ A |
|                      | Control inputs   | $V_{CC} = 3.6$ V,   | $V_I = V_{CC}$ or GND       |                |      | $\pm 1$     |                |      | $\pm 1$     |         |
|                      | Data inputs  | $V_{CC} = 3.6$ V  | $V_I = V_{CC}$              |                |      | 1           |                |      | 1           |         |
|                      |  |   | $V_I = 0$                   |                |      | –5          |                |      | –5          |         |
| $I_{off}$            |  | $V_{CC} = 0$ ,  | $V_I$ or $V_O = 0$ to 4.5 V |                |      |             |                |      | $\pm 100$   | $\mu$ A |
| $I_{I(hold)}$        | Data inputs  | $V_{CC} = 3$ V  | $V_I = 0.8$ V               | 75             |      |             | 75             |      |             | $\mu$ A |
|                      |  |   | $V_I = 2$ V                 | –75            |      |             | –75            |      |             |         |
|                      |  | $V_{CC} = 3.6$ V‡,  | $V_I = 0$ to 3.6 V          |                |      |             |                |      | 500<br>–750 |         |
| $I_{OZH}$            |  | $V_{CC} = 3.6$ V,   | $V_O = 3$ V                 |                |      | 5           |                |      | 5           | $\mu$ A |
| $I_{OZL}$            |  | $V_{CC} = 3.6$ V,   | $V_O = 0.5$ V               |                |      | –5          |                |      | –5          | $\mu$ A |
| $I_{OZPU}$           |  | $V_{CC} = 0$ to 1.5 V, $V_O = 0.5$ V to 3 V,<br>$\overline{OE} = \text{don't care}$ |                             |                |      | $\pm 100^*$ |                |      | $\pm 100$   | $\mu$ A |
| $I_{OZPD}$           |  | $V_{CC} = 1.5$ V to 0, $V_O = 0.5$ V to 3 V,<br>$\overline{OE} = \text{don't care}$ |                             |                |      | $\pm 100^*$ |                |      | $\pm 100$   | $\mu$ A |
| $I_{CC}$             | $V_{CC} = 3.6$ V,<br>$I_O = 0$ ,<br>$V_I = V_{CC}$ or GND                                  |   | Outputs high                |                |      | 0.19        |                |      | 0.19        | mA      |
|                      |  |   | Outputs low                 |                |      | 5           |                |      | 5           |         |
|                      |  |   | Outputs disabled            |                |      | 0.19        |                |      | 0.19        |         |
| $\Delta I_{CC}^{\S}$ | $V_{CC} = 3$ V to 3.6 V, One input at $V_{CC} - 0.6$ V,<br>Other inputs at $V_{CC}$ or GND |   |                             |                |      | 0.2         |                |      | 0.2         | mA      |
| $C_i$                | $V_I = 3$ V or 0   |   |                             |                |      | 4           |                |      | 4           | pF      |
| $C_O$                | $V_O = 3$ V or 0   |   |                             |                |      | 9           |                |      | 9           | pF      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† All typical values are at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$ .

‡ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

§ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}$  or GND.



**SN54LVTH162244, SN74LVTH162244**  
**3.3-V ABT 16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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switching characteristics over recommended operating free-air temperature range,  $C_L = 50$  pF  
(unless otherwise noted) (see Figure 1)

| PARAMETER          | FROM<br>(INPUT) | TO<br>(OUTPUT) | SN54LVTH162244                                |     |                         |     | SN74LVTH162244                                |      |     |                         | UNIT |     |
|--------------------|-----------------|----------------|---|-----|-------------------------|-----|---|------|-----|-------------------------|------|-----|
|                    |                 |                | $V_{CC} = 3.3\text{ V}$<br>$\pm 0.3\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V}$<br>$\pm 0.3\text{ V}$ |      |     | $V_{CC} = 2.7\text{ V}$ |      |     |
|                    |                 |                | MIN   | MAX | MIN                     | MAX | MIN   | TYP† | MAX | MIN                     |      | MAX |
| t <sub>PLH</sub>   | A               | Y              | 1.1   | 4.6 | 5.1                     |     | 1.4   | 3.4  | 4   | 4.8                     |      | ns  |
| t <sub>PHL</sub>   |                 |                | 1.1   | 3.9 | 4.5                     |     | 1.2   | 2.9  | 3.6 | 4.1                     |      |     |
| t <sub>PZH</sub>   | $\overline{OE}$ | Y              | 1.1   | 5.4 | 6.7                     |     | 1.2   | 3.9  | 5.1 | 6.5                     |      | ns  |
| t <sub>PZL</sub>   |                 |                | 1.3   | 4.9 | 6.1                     |     | 1.4   | 3.8  | 4.5 | 5.8                     |      |     |
| t <sub>PHZ</sub>   | $\overline{OE}$ | Y              | 1.6   | 5.9 | 6.5                     |     | 2.2   | 4.4  | 5   | 5.4                     |      | ns  |
| t <sub>PLZ</sub>   |                 |                | 1   | 5.9 | 5.8                     |     | 2   | 4.2  | 5   | 5.4                     |      |     |
| t <sub>sk(o)</sub> |                 |                |   |     |                         |     | 0.5   |      |     |                         |      | ns  |

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

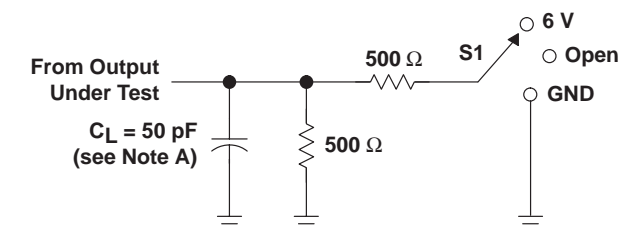
# SN54LVTH162244, SN74LVTH162244

## 3.3-V ABT 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

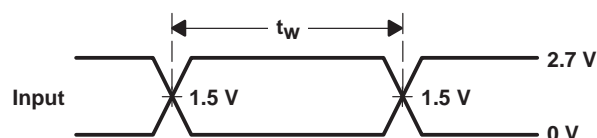
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#### PARAMETER MEASUREMENT INFORMATION

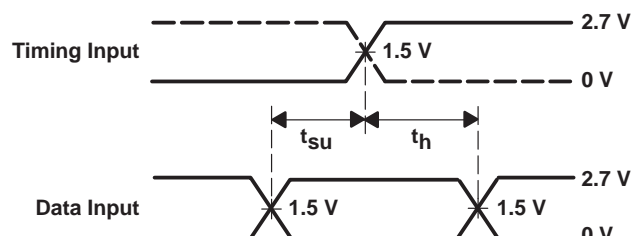


LOAD CIRCUIT

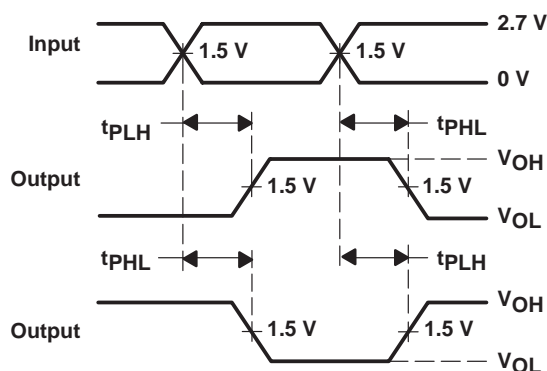
| TEST              | S1   |
|-------------------|------|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 6 V  |
| $t_{PHZ}/t_{PZH}$ | GND  |



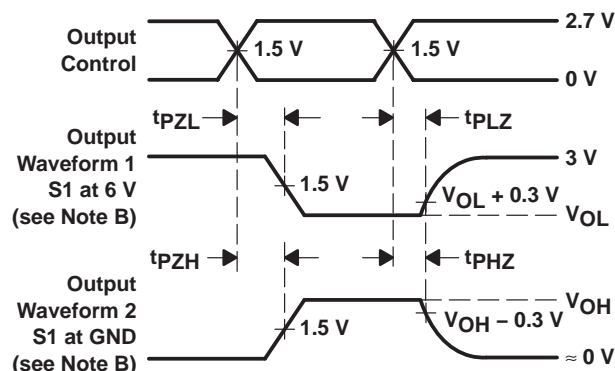
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



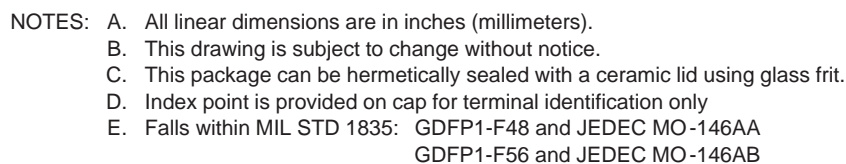
VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

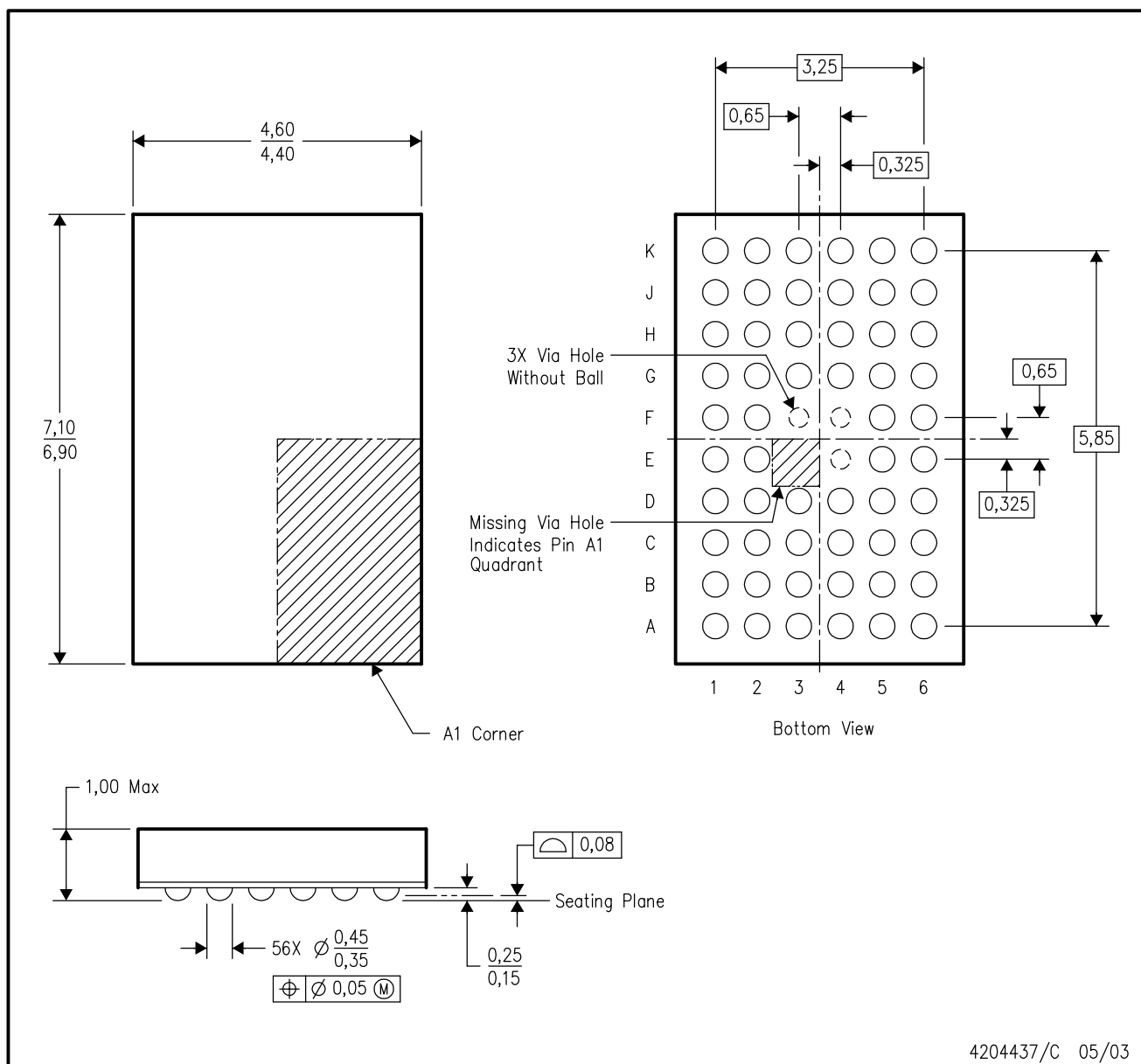
## CERAMIC DUAL FLATPACK

48 LEADS SHOWN



## ZQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY

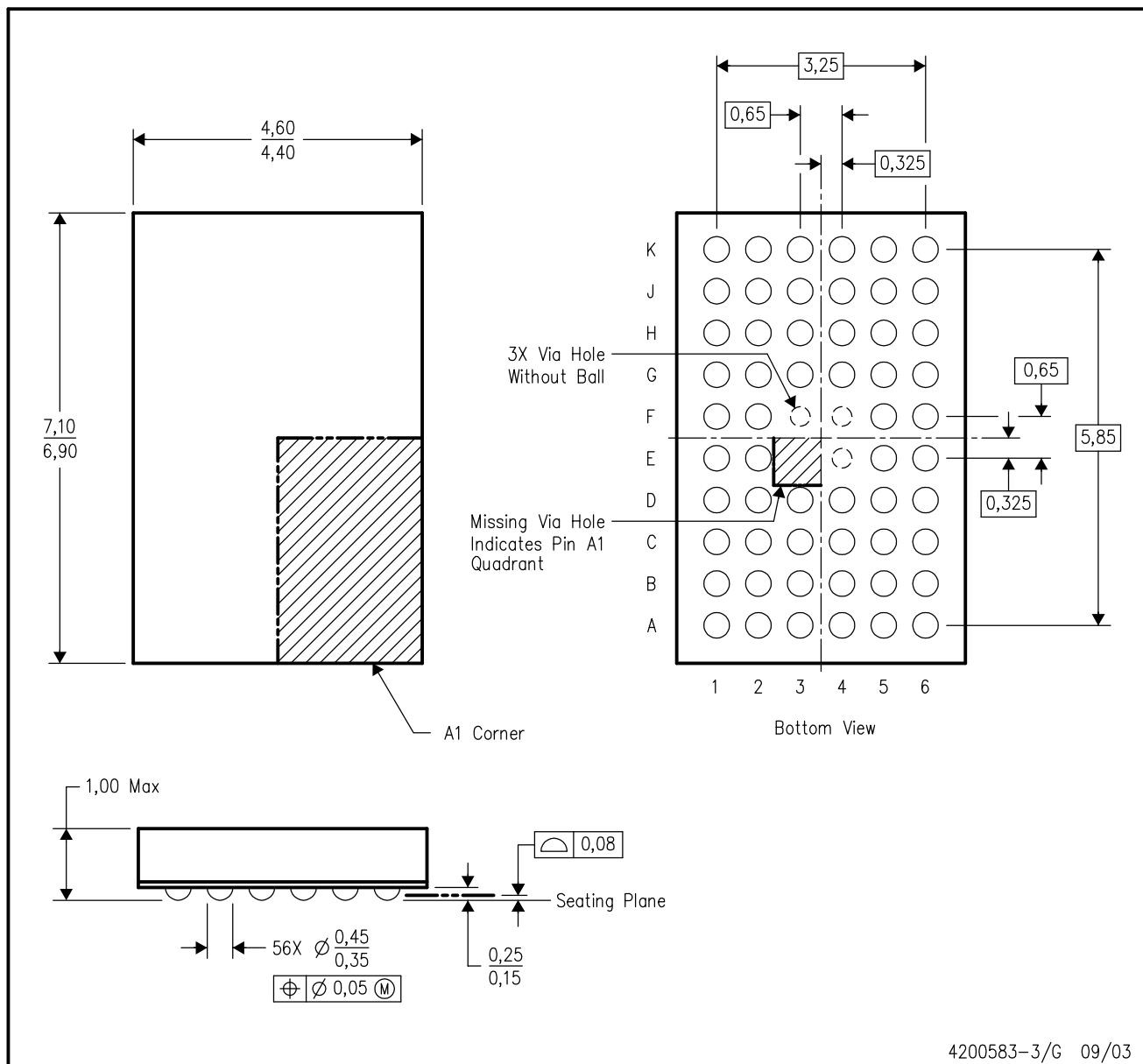


- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - MicroStar Junior™ BGA configuration.
  - Falls within JEDEC MO-225 variation BA.
  - This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).



## GQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY



4200583-3/G 09/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. MicroStar Junior™ BGA configuration.
  - D. Falls within JEDEC MO-225 variation BA.
  - E. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

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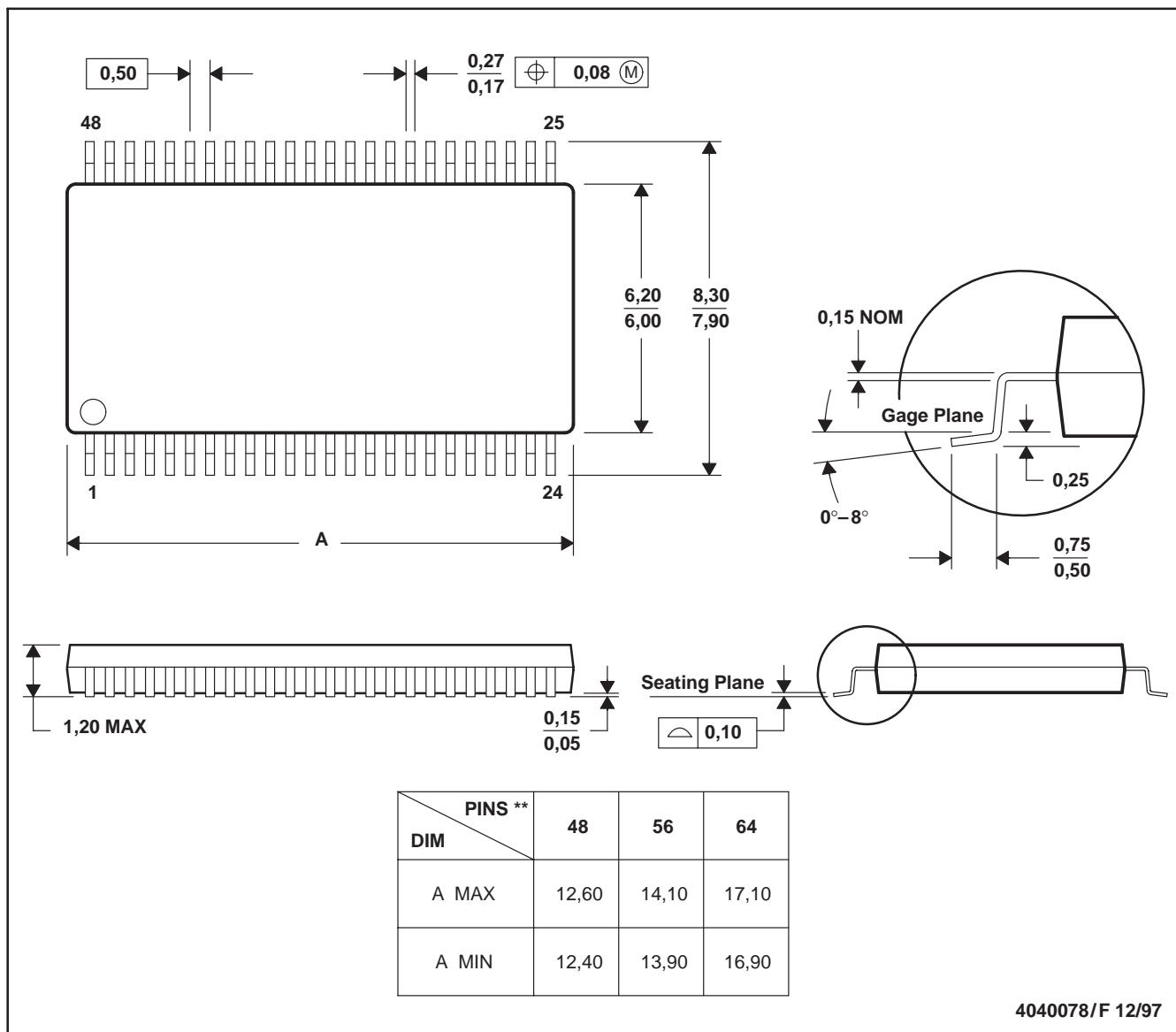
## DL (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-118

**DGG (R-PDSO-G\*\*)****PLASTIC SMALL-OUTLINE PACKAGE****48 PINS SHOWN**

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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| DSP              | <a href="http://dsp.ti.com">dsp.ti.com</a>                         | Broadband           | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
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| Microcontrollers | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a> | Security            | <a href="http://www.ti.com/security">www.ti.com/security</a>             |
|                  |  | Telephony           | <a href="http://www.ti.com/telephony">www.ti.com/telephony</a>           |
|                  |  | Video & Imaging     | <a href="http://www.ti.com/video">www.ti.com/video</a>                   |
|                  |  | Wireless            | <a href="http://www.ti.com/wireless">www.ti.com/wireless</a>             |

Mailing Address: Texas Instruments  
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